

## PRODUCT/PROCESS CHANGE NOTIFICATION (PCN)

PCN: 2005-16 Date: October 28, 2005	T			
<b>PCN: 2005-16</b> Date: October 28, 2005	MEANG OF DICTINGUISHING OHANGED DEVICES.			
Products Affected: PCI9656-BA66BI, PCI9056-BA66BI, PCI6150-BB66BC, PCI6154-BA66BC, PCI6154-BB66BC, PCI6254-BB66BC,	MEANS OF DISTINGUISHING CHANGED DEVICES:  Not Applicable			
PCI9656-BA66BI G, PCI9056-BA66BI G, PCI6150-BB66BC G, PCI6154-BB66BC G, PCI6254-BB66BC G				
Using PBGA packages				
Manufacturing Location Affected: N/A Date Effective: Immediately				
Contact: Sarat Misro	al Data: Substrate Qualification Data (please see attached )  STD ASE PLX PBGA  Gr ASE0507-041 PLX  11721 PEPOPT pdf			
	31X31 REPORT.pdf HSBGA 31X31 REPOR			
Samples: Not applicable				
<b>DESCRIPTION AND PURPOSE OF CHANGE:</b> New package substrate supplier SMI, Malaysia will be qualified for additional manufacturing capacity to continuously supply products without disruption.				
RELIABILITY/QUALIFICATION SUMMARY:  We expect no impact to the reliability since SMI, Malaysia is a qualified substrate vendor for ASE, Malaysia. PBGA products are manufactured in ASE using SMI substrates in high volume manufacturing.				
CUSTOMER ACKNOWLEDGEMENT OF RECEIPT:				
Please FAX the acknowledgement below to Sarat Misro at (408) 735-9094 or E-mail <b>qa@plxtech.com</b> to grant approval or request additional information. If PLX does not receive acknowledgement within 90 days of this notice, we will assume that this change is approved.				
Customer:				
Name/Date: E-	mail Address:			
Title: Ph	one# /Fax# :/			
<b>Customer Comments:</b>				
REC'D. BY:	DATE:			